

	Type	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L3	14867	semiconductor adj laser adj chip adj die adj bond\$ adjn bond\$ adj surface	USPAT	2001/08/17 15:58
2	BRS	L5	558	conductive adj die adj bond\$ adj paste adjn light adj emit\$ adj point	USPAT	2001/08/17 16:03
3	BRS	L6	246047	conductive adj die adj bond\$ adj paste adj adheres adjn end adj surfaces adjn semiconductor	USPAT	2001/08/17 16:07
4	BRS	L10	2204	die adj bond\$ adj paste adj contain\$ adj silver adj flakes adjn conductive adj filler	USPAT	2001/08/17 16:17
5	BRS	L12	2996	3 and 6	USPAT	2001/08/17 16:17
6	BRS	L13	77	3 and 10	USPAT	2001/08/17 16:17
7	BRS	L14	3	11 and 12 and 13	USPAT	2001/08/17 16:18
8	BRS	L11	15	3 and 5	USPAT	2001/08/17 16:39
9	IS&R	L16	422	("372/36").CCLS.	USPAT	2001/08/17 16:40
10	IS&R	L17	0	("11 and 16").PN.	USPAT	2001/08/17 16:41
11	IS&R	L18	1308	("372/50").CCLS.	USPAT	2001/08/17 16:42
12	BRS	L19	0	11 and 18	USPAT	2001/08/17 16:42
13	BRS	L20	4	11 and 16	USPAT	2001/08/17 17:02

	Comments	Error Definition	Errors
1		Truncation Overflow. Return string from Server is: 5`220189`	1
2		Truncation Overflow. Return string from Server is: 5`297349`	1
3		Truncation Overflow. Return string from Server is: 5`297349`	1
4		Truncation Overflow. Return string from Server is: 5`142288`	1
5			0
6			0
7			0
8			0
9			0
10			0
11			0
12			0
13			0